VS-ST230C Series

Vishay Semiconductors



Phase Control Thyristors (Hockey PUK Version), 410 A



TO-200AB (A-PUK)

PRODUCT SUMMARY							
Package	TO-200AB (A-PUK)						
Diode variation	Single SCR						
I _{T(AV)}	410 A						
V _{DRM} /V _{RRM}	400 V, 800 V, 1200 V, 1400 V, 1600 V, 1800 V, 2000 V						
V _{TM}	1.69 V						
I _{GT}	90 mA						
TJ	-40 °C to 125 °C						

FEATURES

- Center amplifying gate
- Metal case with ceramic insulator
- International standard case TO-200AB (A-PUK)
- Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS								
PARAMETER	TEST CONDITIONS	VALUES	UNITS					
		410	A					
I _{T(AV)}	T _{hs}	55	°C					
I		780	A					
I _{T(RMS)}	T _{hs}	25	°C					
1	50 Hz	5700	A					
ITSM	60 Hz	5970	A					
l ² t	50 Hz	163	kA ² s					
1-1	60 Hz	149	KA-S					
V _{DRM} /V _{RRM}		400 to 2000	V					
t _q	Typical	100	μs					
TJ		-40 to 125	°C					

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS								
TYPE NUMBER	VOLTAGE CODE	V _{DRM} /V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	I_{DRM}/I_{RRM} , MAXIMUM AT T _J = T _J MAXIMUM mA				
	04	400	500					
	08	800	900					
	12	1200	1300					
VS-ST230CC	14	1400	1500	30				
16 18		1600	1700					
		1800	1900					
	20		2100					

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ABSOLUTE MAXIMUM RATING	S					
PARAMETER	SYMBOL		TEST CONDITIONS			UNITS
Maximum average on-state current	1	180° condu	180° conduction, half sine wave			А
at heatsink temperature	I _{T(AV)}	double side	(single side) co	oled	55 (85)	°C
Maximum RMS on-state current	I _{T(RMS)}	DC at 25 °C	heatsink temp	erature double side cooled	780	
		t = 10 ms	No voltage		5700	
Maximum peak, one-cycle		t = 8.3 ms	reapplied		5970	А
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}	Sinusoidal half wave, initial $T_J = T_J$ maximum	4800	kA ² s
		t = 8.3 ms	reapplied		5000	
Maria and Protocology	l ² t	t = 10 ms	No voltage reapplied 100 % V _{BBM}		163	
		t = 8.3 ms			148	
Maximum I ² t for fusing		t = 10 ms			115	
		t = 8.3 ms	reapplied		105	
Maximum I ² \sqrt{t} for fusing	l²√t	t = 0.1 to 10) ms, no voltage	reapplied	1630	kA²√s
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	$x \mid_{T(AV)} < I < \pi x$	$I_{T(AV)}$), $T_J = T_J$ maximum	0.92	v
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)})$), T _J = T _J maxin	num	0.98	v
Low level value of on-state slope resistance	r _{t1}	(16.7 % x π	(16.7 % x π x $I_{T(AV)} < I < \pi$ x $I_{T(AV)}$), $T_J = T_J$ maximum			mΩ
High level value of on-state slope resistance	r _{t2}	$(I > \pi x I_{T(AV)}), T_J = T_J maximum$			0.81	11122
Maximum on-state voltage	V _{TM}	$I_{pk} = 880 \text{ A}, T_J = T_J \text{ maximum, } t_p = 10 \text{ ms sine pulse}$			1.69	V
Maximum holding current	Ι _Η	T _ 05 °C	anada aunrhi 1	2 V resistive load	600	mA
Maximum (typical) latching current	١L	$1_{\rm J} = 25$ C,	anoue supply 1		1000 (300)	

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum non-repetitive rate of rise of turned-on current	dl/dt	Gate drive 20 V, 20 $\Omega, t_r \leq$ 1 μs T_J = T_J maximum, anode voltage \leq 80 % V_{DRM}	1000	A/µs
Typical delay time	t _d	Gate current 1 A, dl _g /dt = 1 A/ μ s V _d = 0.67 % V _{DRM} , T _J = 25 °C	1.0	
Typical turn-off time	tq	I_{TM} = 300 A, T_J = T_J maximum, dl/dt = 20 A/µs, V_R = 50 V, dV/dt = 20 V/µs, gate 0 V 100 $\Omega,$ t_p = 500 µs	100	μs

BLOCKING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = T_J maximum linear to 80 \% rated V_{DRM}$	500	V/µs
Maximum peak reverse and off-state leakage current	I _{RRM} , I _{DRM}	$T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied	30	mA





TRIGGERING								
PARAMETER	SYMBOL	TE	ST CONDITIONS	VAL	UNITS			
FARAMETER	STIVIDOL	16	STCONDITIONS	TYP.	MAX.	UNITS		
Maximum peak gate power	P _{GM}	$T_J = T_J$ maximum,	, t _p ≤ 5 ms	10).0	w		
Maximum average gate power	P _{G(AV)}	$T_J = T_J$ maximum,	, f = 50 Hz, d% = 50	2	.0	vv		
Maximum peak positive gate current	I _{GM}	$T_J = T_J$ maximum,	, t _p ≤ 5 ms	3	.0	А		
Maximum peak positive gate voltage	+ V _{GM}		+ < 5 mg	20				
Maximum peak negative gate voltage	- V _{GM}	ij = ij maximum,	$T_J = T_J$ maximum, $t_p \le 5$ ms					
		T _J = - 40 °C		180	-			
DC gate current required to trigger	I _{GT}	T _J = 25 °C		90	150	mA		
		T _J = 125 °C	Maximum required gate trigger/ current/voltage are the lowest	40	-			
		T _J = - 40 °C	value which will trigger all units 12 V anode to cathode applied	2.9	-			
DC gate voltage required to trigger	V _{GT}	T _J = 25 °C	12 v anode to cathode applied	1.8	3.0	V		
		T _J = 125 °C		1.2	-			
DC gate current not to trigger	I _{GD}	T. T. maximum	Maximum gate current/voltage not to trigger is the maximum	10		mA		
DC gate voltage not to trigger	V _{GD}	T _J = T _J maximum	value which will not trigger any unit with rated V _{DRM} anode to cathode applied	0.25		v		

THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER SYMBOL		TEST CONDITIONS	VALUES	UNITS			
Maximum operating temperature range	TJ		- 40 to 125	°C			
Maximum storage temperature range	T _{Stg}		- 40 to 150				
Maximum thermal resistance,	D	DC operation single side cooled	0.17				
junction to heatsink	R _{thJ-hs}	DC operation double side cooled	0.08	K/W			
Maximum thermal resistance.	D	DC operation single side cooled	0.033				
case to heatsink	R _{thC-hs}	DC operation double side cooled 0.017					
Mounting force, ± 10 %			4900 (500)	N (kg)			
Approximate weight			50	g			
Case style		See dimensions - link at the end of datasheet	TO-200AB (A	-PUK)			

$\Delta \mathbf{R}_{\text{thJC}}$ CONDUCTION						
CONDUCTION ANGLE	SINUSOIDAL	CONDUCTION	RECTANGULAF	R CONDUCTION	TEST CONDITIONS	UNITS
CONDUCTION ANGLE	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE			UNITS
180°	0.015	0.017	0.011	0.011		
120°	0.018	0.019	0.019	0.019		
90°	0.024	0.024	0.026	0.026	$T_J = T_J maximum$	K/W
60°	0.035	0.035	0.036	0.036		
30°	0.060	0.060	0.060	0.061		

Note

• The table above shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

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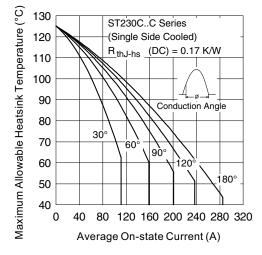


Fig. 1 - Current Ratings Characteristics

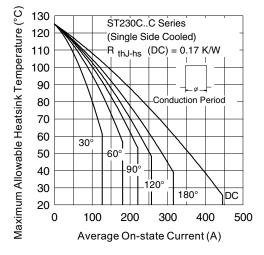
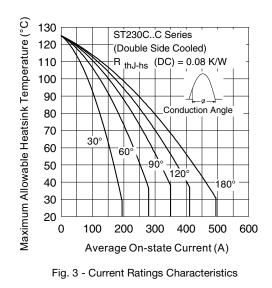


Fig. 2 - Current Ratings Characteristics





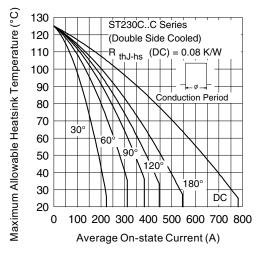


Fig. 4 - Current Ratings Characteristics

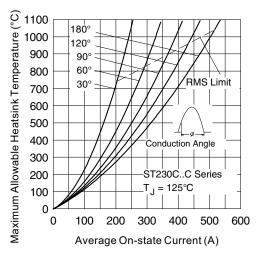
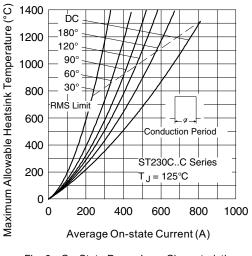


Fig. 5 - On-State Power Loss Characteristics





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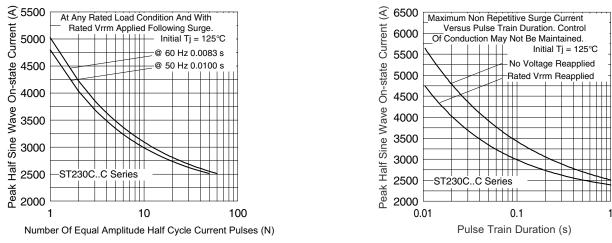
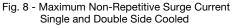


Fig. 7 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

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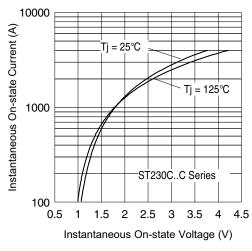
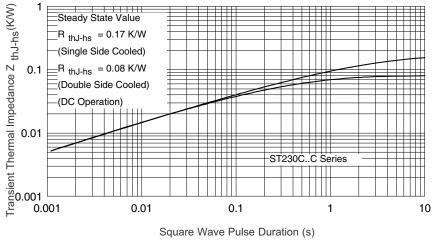


Fig. 9 - On-State Voltage Drop Characteristics





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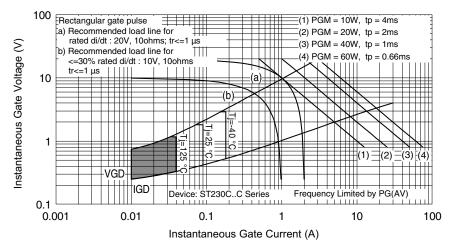


Fig. 11 - Gate Characteristics

ORDERING INFORMATION TABLE

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Device code	VS-	ST	23	0	С	20	с	1	-
		2	3	4	5	6	7	8	9
	1 -	Visł	nay Sen	niconduo	ctors pro	oduct			
	2 -	Thy	ristor						
	3 -	Ess	ential p	art num	ber				
	4 -	0 =	Conver	ter grad	е				
	5 -	C =	Ceram	c PUK					
	6 -	Volt	age coo	de x 100	= V _{RRM}	l (see V	oltage F	Ratings	table)
	7 -	C =	PUK ca	ase TO-2	200AB (A-PUK)			
	8 -	0 =	Eyelet t	erminals	s (gate a	and auxi	liary ca	thode u	nsolder
		1 =	1 = Fast-on terminals (gate and auxiliary cathode unsoldered lea						
		2 =	Eyelet 1	erminal	s (gate a	and auxi	iliary ca	thode s	oldered
		3 =	Fast-on	termina	als (gate	and au	xiliary c	athode	soldere
	9 -	Crit	ical dV/	dt: • No	ne = 500) V/µs (Standar	d selec	tion)
				• L =	1000 V	/µs (Spe	ecial se	lection)	

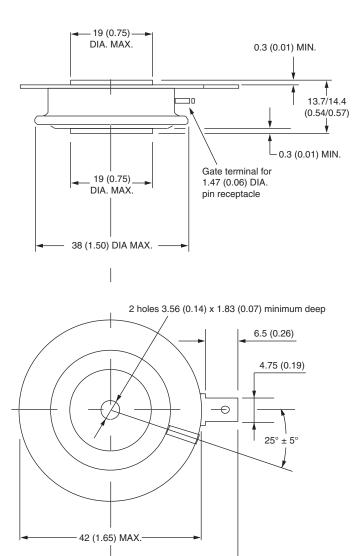
LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?95074				



TO-200AB (A-PUK)

DIMENSIONS in millimeters (inches)

Anode to gate Creepage distance: 7.62 (0.30) minimum Strike distance: 7.12 (0.28) minimum



Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)

28 (1.10)



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